

APPROVAL SHEET

MULTILAYER CERAMIC CAPACITORS

Ultra-small Series (6.3V to 50V)

0201 Size

NP0, X7R, X5R Dielectrics

RoHS Compliance

*Contents in this sheet are subject to change without prior notice.



1. INTRODUCTION

MLCC consists of a conducting material and electrodes. To manufacture a chip-type SMT and achieve miniaturization, high density and high efficiency, ceramic condensers are used.

0201 MLCC is performed by high precision technology achieve high capacitance in unit size and ensure the stability and reliability of products.

2. FEATURES

- b. High capacitance in unit size.
- c. High precision dimensional tolerances.
- d. Suitable used in high-accuracy automatic mounting machine.

3. APPLICATIONS

- a. Miniature microwave module.
- b. Portable equipments (ex. Mobile phone, PDA).
- c. High frequency circuits.

4. HOW TO ORDER

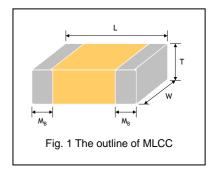
<u>0201</u>	<u>B</u>	<u>102</u>	<u>K</u>	<u>250</u>	<u>C</u>	I
<u>Size</u>	Dielectric	<u>Capacitance</u>	<u>Tolerance</u>	Rated voltage	<u>Termination</u>	<u>Packaging</u>
Inch (mm) 0201 (0603)	N=NP0 (C0G) B=X7R X=X5R	Two significant digits followed by no. of zeros. And R is in place of decimal point. eg.: 0R5=0.5pF 1R0=1.0pF	A=±0.05pF B=±0.1pF C=±0.25pF D=±0.5pF F=±1% G=±2% J=±5% K=±10%	Two significant digits followed by no. of zeros. And R is in place of decimal point. 6R3=6.3 VDC 100=10 VDC 160=16 VDC	C =Cu/Ni/Sn	T=7" reeled
		102=10x10 ² =1000pF	M =±20% Z =-20/+80%	250=25 VDC 500=50 VDC		
		_ 1000pi	20,10070	-00-00 VD0		



5. EXTERNAL DIMENSIONS

Size Inch (mm)	L (mm)	W (mm)	T (mm)/Syr	nbol	M _B (mm)
0204 (0602)	0.60±0.03	0.30±0.03	0.30±0.03		0.45.0.05
0201 (0603)	0.60±0.05 ^{#1}	0.30±0.05 ^{#1}	0.30±0.05 ^{#1}	L	0.15±0.05

^{*} Reflow soldering only. #1 For 0201/Cap≥0.68uF



6. GENERAL ELECTRICAL DATA

Size		0201		
Dielectric	NP0	X7R	X5R	
Capacitance*	0.1pF to 120pF	100pF to 10nF	100pF to 1μF	
	Cap≤5pF ^{#1} : A (±0.05pF), B (±0.1pF), C (±0.25pF) 5pF <cap<10pf: (±0.1pf),c="" (±0.25pf),d(±0.5pf)="" (±1%),="" (±10%)<="" (±2%),="" (±5%),="" b="" cap≥10pf:="" f="" g="" j="" k="" th=""><th>J (±5%), K (±10%), M (±20%)</th><th>J (±5%),K (±10%), M (±20%)</th></cap<10pf:>	J (±5%), K (±10%), M (±20%)	J (±5%),K (±10%), M (±20%)	
Rated voltage (WVDC)	16V, 25V, 50V	6.3V, 10V, 16V, 25V, 50V	6.3V, 10V, 16V, 25V, 50V	
Tan δ / Q*	Cap<30pF, Q≥400+20C Cap≥30pF, Q≥1000	Note 1		
Insulation resistance at Ur ≥10GΩ		≥10GΩ or RxC≥500ΩxF whichever is less		
Operating temperature	-55 to +125°	С	-55 to +85°C	
Capacitance change	±30ppm ±15%			
Termination	Ni/Sn (lead-free termination)			

^{#1:} NP0, 0.1pF product only provide B tolerance

NP0: Apply 1.0±0.2Vrms, 1.0MHz±10% at the condition of 25°C ambient temperature.

X7R, X5R: Apply 1.0±0.2Vrms, 1.0kHz±10%(0201/6.3V,Cap≥224 : 0.5±0.2Vrms, 1.0kHz±10%) at the condition of 25°C ambient temperature.

** Preconditioning for Class II MLCC: Perform a heat treatment at 150±10°C for 1 hour, then leave in ambient condition for 24±2 hours before measurement.

Note 1: X7R/X5R

Rated vol.	D.F.	Exception of D.F.				
≥50V	≤3%					
25V	≤3.5%	≤5%	0201≥0.01uF			
16V	≤3.5%	≤5%	0201≥0.01uF			
10V	≤5%	≤10%	0201≥0.012uF			
100	≥5%	≤15%	0201≥0.1uF			
6.3V	≤10%	≤15%	0201≥0.1uF			

^{*} Measured at 30~70% related humidity.



7. CAPACITANCE RANGE

	SIZE		0201	
[DIELECTRIC		NP0	
RA	TED VOLTAGE			
	(VDC)	16	25	50
	0.1pF (0R1)	L	L	L
	0.2pF (0R2)	L	L	L
	0.3pF (0R3)	L	L	L
	0.4pF (0R4)	L	L	L
	0.5pF (0R5)	L	L	L
	1.0pF (1R0)	L	L	L
	1.2pF (1R2)	L	L	L
	1.5pF (1R5)	L	L	L
	1.8pF (1R8)	L	L	L
	2.2pF (2R2)	L	L	L
	2.7pF (2R7)	L	L	L
	3.0pF (3R0)	L	L	L
	3.3pF (3R3)	L	L	L
	3.9pF (3R9)	L	L	L
ø	4.0pF(4R0)	L	L	L
Capacitance	4.7pF (4R7)	L	L	L
Scit	5.6pF (5R6)	L	L	L
ар	6.8pF (6R8)	L	L	L
O	8.2pF (8R2)	L	L	L
	10pF (100)	L	L	L
	12pF (120)	L	L	L
	15pF (150)	L	L	L
	18pF (180)	L	L	L
	22pF (220)	L	L	L
	27pF (270)	L	L	L
	33pF (330)	L	L	L
	39pF (390)	L	L	L
	47pF (470)	L	L	L
	56pF (560)	L	L	L
	68pF (680)	L	L	L
	82pF (820)	L	L	L
	100pF (101)	L	L	L
	120pF (121)	L	L	L

SIZE		0201									
DIELECTRIC		X7R			X5R						
R	ATED VOLTAGE (VDC)	6.3	10	16	25	50	6.3	10	16	25	50
	100pF (101)			L	L	L			L	L	L
	120pF (121)			L	L	L			L	L	L
	150pF (151)			L	L	L			L	L	L
	180pF (181)			L	L	L			L	L	L
	220pF (221)			L	L	L			L	L	L
	270pF (271)			L	L	L			L	L	L
	330pF (331)			L	L	L			L	L	L
	390pF (391)			L	L	L			L	L	L
	470pF (471)			L	L	L			L	L	L
	560pF (561)			L	L	L			L	L	L
	680pF (681)			L	L	L			L	L	L
	820pF (821)			L	L	L			L	L	L
	1,000pF (102)	L	L	L	L	L		L	L	L	L
4	1,200pF (122)	L	L	L	L			L	L		
nce	1,500pF (152)	L	L	L	L			L	L		
Capacitance	2,200pF (222)	L	L	L				L	L		
pac	3,300pF (332)	L	L	L				L	L		
Sa	4,700pF (472)	L	L	L				L	L		
	5,600pF (562)	L	L					L			
	6,800pF (682)	L	L					L			
	8,200pF (822)	L	L					L			
	0.010µF (103)	L	L	L			L	L	L	L	
	0.015µF (153)						L	L			
	0.022µF (223)						L	L			
	0.033µF (333)						L	L			
	0.047µF (473)						L	L			
	0.068µF (683)						L	L			
	0.082µF (823)						L	L			
	0.10µF (104)						L	L	L		
	0.22µF (224)						L	L			
	0.47µF (474)						L				
	1.0µF (105)						L	L			

The letter in cell is expressed the symbol of product thickness.

8. PACKAGING DIMENSION AND QUANTITY

Cina	Thiskness (mm)/Cimb	-1	Paper tape			
Size	Thickness (mm)/Symbol		7" reel	13" reel		
0204 (0602)	0.30±0.03		15,000	70,000		
0201 (0603)	0.30±0.05 ^{#1}	L	15.000	-		

Unit: pieces

#1 For 0201/Cap \geq 0.68uF



9. RELIABILITY TEST CONDITIONS AND REQUIREMENTS

No.	Item		Test Condition		Requirements			
1.	Visual and Mechanical				* No remarkable defect. * Dimensions to conform to individual specification sheet.			
2.	Capacitance	Class I: NP0 *				ceed the	limits give	en in the detailed spec.
3.	Q/ D.F. (Dissipation	Cap>1000pF,	1.0±0.2Vrms, 1MHz±10% 1.0±0.2Vrms, 1KHz±10%		NP0: Cap≥30pF, Q≥1000; Cap<30pF, Q≥400+20C X7R, X5R:			
	Factor)	Class II: X7R			Rated vol.	D.F.	Exception	on of D.F.
		:	s, 1kHz±10%** ns, 1.0kHz±10% : 0201 ≥0.22 uF(6	3 3 1 / 1	≥50V	≤3%		
		0.510.2 VIII	113, 1.0K112±1070 . 0201 ±0.22 di (0	J.5V)	25V	≤3.5%	≤5%	0201≥0.01uF
					16V	≤3.5%	≤5%	0201≥0.01uF
					40)/	ZE0/	≤10%	0201≥0.012uF
					10V	≤5%	≤15%	0201≥0.1uF
					6.3V	≤10%	≤15%	0201≥0.1uF
4a.	Dielectric Strength	* Duration: 1	tage (≤100V) 250%. to 5 sec. discharge current less than 50mA		* No evidend	e of dama	ge or flas	h over during test.
5.	Insulation	To apply rated	d voltage for max. 120 sec.		≥10GΩ or R	<c≥500ω-l< th=""><th>F whichev</th><th>ver is smaller.</th></c≥500ω-l<>	F whichev	ver is smaller.
	Resistance				Class II (X5F		'R, Y5V)	
					Rated volta		Insulation resistance	
					6.3V; 10V:	0201≥47nI	F ≥10	0 Ω-F
6.	Temperature	With no electi	rical load.					
	Coefficient	T.C.	Operating Temp		T.C.	Capacita	nce Char	nge
		NP0 (C0G)	-55~125°C at 25°C		NP0 (C0G)	Within ±3	30ppm/°C	;
		X7R	-55~125°C at 25°C		X7R	Within ±1	15%	
		X5R	-55~85°C at 25°C		X5R	Within ±1	15%	
7.	Adhesive Strength of Termination	* Pressurizing * Test time: 10	•		* No remarka	able dama	ge or rem	noval of the terminations.
8.	Vibration	* Vibration fre	equency: 10~55 Hz/min.		* No remarka	able dama	ge.	
	Resistance	* Total amplitu			8		•	eet initial spec.
		* Test time: 6	hrs. (Two hrs each in three mutua	lly				
		perpendicular	r directions.)					
		* Measureme 24±2 hrs.	ent to be made after keeping at roo	m temp. for				
9.	Solderability	* Solder temperature: 235±5°C			95% min. co	verage of	all metali:	zed area.
10	Bending Test	* Dipping time: 2±0.5 sec. * The middle part of substrate shall be pressurized by means			* No remarkable demage			
10.	Denuing lest	of the pressurizing rod at a rate of about 1 mm per second unti			* No remarkable damage. il * Can change:			
		the deflection becomes 1 mm and then the pressure shall be maintained for 5±1 sec.						
		1	ent to be made after keeping at roo	m temp. for	Y5V: within ±30%			
		24±2 hrs.	· -		(This capaci	tance char	nge mean	s the change of capacitance under
					specified flexure of substrate from the capacitance measured before			
					the test.)			

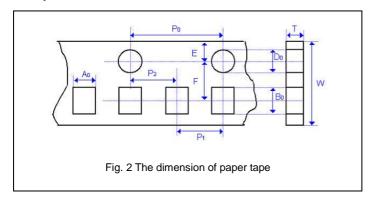
No.	Item	Test Condition	Requirements			
11.	Resistance to Soldering Heat	* Solder temperature: 260±5°C * Dipping time: 10±1 sec * Preheating: 120 to 150°C for 1 minute before immerse th capacitor in a eutectic solder. * Before initial measurement (Class II only): Perform 150+0/-10°C for 1 hr and then set for 24±2 hrs at room tem * Measurement to be made after keeping at room temp. for 24±2 hrs.	* No remarkable damage. * Cap change: NP0: within ±2.5% or ±0.25pF whichever is larger. X7R, X5R: within ±7.5% Y5V: within ±20% * Q/D.F., I.R. and dielectric strength: To meet initial requirements. * 25% max. leaching on each edge.			
12.	Temperature Cycle	* Conduct the five cycles according to the temperatures and time. Step Temp. (°C) Time (min.) 1 Min. operating temp. +0/-3 30±3 2 Room temp. 2~3 3 Max. operating temp. +3/-0 30±3 4 Room temp. 2~3 * Before initial measurement (Class II only): Perform 150+0/-10°C for 1 hr and then set for 24±2 hrs at room temp. for 24±2 hrs.	Cap change: NP0: within ±2.5% or ±0.25pF whichever is larger. X7R, X5R: within ±7.5% Y5V: within ±20% Q/D.F., I.R. and dielectric strength: To meet initial requirements.			
13.	Humidity (Steady State)	* Test temp.: 40±2°C * Humidity: 90~95% RH * Test time: 500+24/-0hrs. *Before initial measurement (Class II only): Perform 150+0/-10°C for 1 hr and then set for 24±2 hrs at room tem * Measurement to be made after keeping at room temp. for 24±2 hrs.	* No remarkable damage. * Cap change: NP0: within ±5.0% or ±0.5pF whichever is larger. X7R, X5R: ≥10V, within ±12.5%, 10V ≥ 0.1μF, within ±25%; 6.3V, within ±25% Y5V: ≥10V, within ±30% 6.3V, within ±30/-40% * Q/D.F. value: NP0: Cap≥30pF, Q≥350; 10pF≤Cap<30pF, Q≥275+2.5C Cap<10pF; Q≥200+10C X7R, X5R:			
			Rated vol. D.F. Exception of D.F. ≥50V ≤6% 25V ≤5% ≤10% 0201≥0.01uF 16V ≤5% ≤15% 0201≥0.01uF 10V ≤7.5% ≤15% 0201≥0.012uF ≤20% 0201≥0.1uF 6.3V ≤15% ≤30% 0201≥0.1uF * I.R.: ≥10V, ≥1GΩ or RxC≥50Ω-F whichever is smaller. 6.3V; 10V:0201≥47nF, RxC≥10Ω-F			

No.	Item	Test Condition				Requ	irements
14.	Humidity Load (Damp Heat)	* No remarkable damage. * Cap change: NP0: within ±7.5% or ±0.75pF whichever is larger. X7R, X5R: ≥10V, within ±12.5%, 10V ≥ 0.1μF, within ±25%; 6.3V, within ±25% Y5V: ≥10V, within ±30% 6.3V, within ±30/-40% * Q/D.F. value: NP0: Cap≥30pF, Q≥200; Cap<30pF, Q≥100+10/3C					
			: 1	X7R, X5R: Rated vol.	D.F.	Exceptio	n of D.F.
				≥50V	≤6%		
				25V	≤5%	≤10%	0201≥0.01uF
				16V	≤5%	≤15%	0201≥0.01uF
				10V	≤7.5%	≤15%	0201≥0.012uF
				100	=1.576	≤20%	0201≥0.1uF
			ļΙ	6.3V	≤15%	≤30%	0201≥0.1uF
			*			RxC≥25Ω ≥47nF, Rx	Ω-F whichever is smaller. «C≥5Ω-F
15.	High	* Test temp.:	=	No remarkal		U	
	Temperature	NP0, X7R: 125±3°C	* Cap change: NP0: within ±3.0% or ±0.3pF whichever is larger. X7R, X5R: ≥10V, within ±12.5%, 10V ≥0.1µF, within ±25%; 6.3V, within ±25% Y5V: ≥10V, within ±30%				
	Load (Endurance)	X5R,Y5V: 85±3°C * To apply voltage:					
	(Lindurance)	(1) Cap.≥0.1uF : 100% of rated voltage					
		(2) 6.3V: 150% of rated voltage.					
		(3) >6.3V: 200% of rated voltage.			6.	.3V, withir	n +30/-40%
		* Test time: 1000+24/-0 hrs.	:	Q/D.F. value			
		*Before initial measurement (Class II only): To apply test		•	•		≤Cap<30pF, Q≥275+2.5C
		voltage for 1hr at test temp. and then set for 24±2 hrs at room	١,	Cap< X7R, X5R:	iupr; Q≥	:200+10C	
		temp.	1	Rated vol.	D.F.	Exceptio	n of D.F.
		*Measurement to be made after keeping at room temp. for		≥50V	≤6%		
		24±2 hrs		25V	≤5%	≤10%	0201≥0.01uF
				16V	≤5%	≤15%	0201≥0.01uF
				10V	≤7.5%	≤20%	0201≥0.1uF
			١١	6.3V	≤15%	≤30%	0201≥0.1uF
			*				-F whichever is smaller.
			<u>: </u>	0.3V; T	UV.UZUT	-+/11F, K)	(C≥10Ω-F

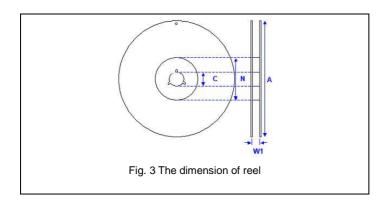


APPENDIXES

■ Tape & reel dimensions

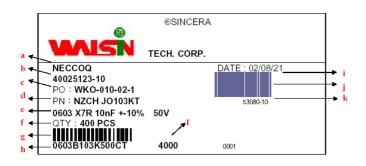


Size	0201
Thickness	L
A_0	0.38±0.05
B_0	0.68±0.05
Т	0.42±0.05
K ₀	-
W	8.00±0.10
P_0	4.00±0.10
10xP ₀	40.0±0.10
P ₁	2.00±0.05
P_2	2.00±0.05
D_0	1.55±0.05
D ₁	-
E	1.75±0.05
F	3.50±0.05



Size	0201					
Reel size	7"	13"				
С	13.0+0.5/-0.2	13.0+0.5/-0.2				
\mathbf{W}_1	8.4+1.5/-0	8.4+1.5/-0				
Α	178.0±0.10	330.0±1.0				
N	60.0+1.0/-0	100±1.0				

Description of customer label

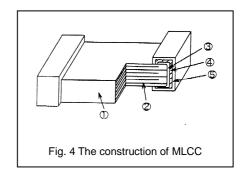


- a. Customer name
- b. WTC order series and item number
- c. Customer P/O
- d. Customer P/N
- e. Description of product
- f. Quantity
- g. Bar code including quantity & WTC P/N or customer
- h. WTC P/N
- i. Shipping date
- j. Order bar code including series and item numbers
- k. Serial number of label



Constructions

No.	Name		NP0, X7R, X5R
1	Ceramic material		BaTiO₃ based
2	Inner electrode		Ni
3		Inner layer	Cu
4	Termination	Middle layer	Ni
(5)		Outer layer	Sn (Matt)



Storage and handling conditions

- (1) To store products at 5 to 40°C ambient temperature and 20 to 70%. related humidity conditions.
- (2) The product is recommended to be used within one year after shipment. Check solderability in case of shelf life extension is needed.

Cautions:

- a. The corrosive gas reacts on the terminal electrodes of capacitors, and results in the poor solderability. Do not store the capacitors in the ambience of corrosive gas (e.g., hydrogen sulfide, sulfur dioxide, chlorine, ammonia gas etc.)
- b. In corrosive atmosphere, solderability might be degraded, and silver migration might occur to cause low reliability.
- c. Due to the dewing by rapid humidity change, or the photochemical change of the terminal electrode by direct sunlight, the solderability and electrical performance may deteriorate. Do not store capacitors under direct sunlight or dewing condition. To store products on the shelf and avoid exposure to moisture.

Recommended soldering conditions

The lead-free termination MLCCs are not only to be used on SMT against lead-free solder paste, but also suitable against lead-containing solder paste. If the optimized solder joint is requested, increasing soldering time, temperature and concentration of N_2 within oven are recommended.

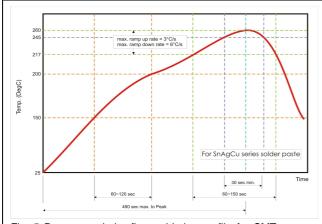


Fig. 5 Recommended reflow soldering profile for SMT process with SnAgCu series solder paste.

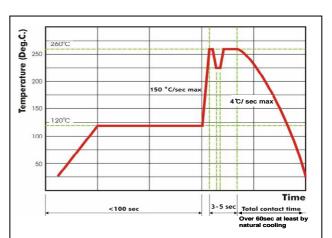


Fig. 6 Recommended wave soldering profile for SMT process with SnAgCu series solder.